

EXPEDITED PROCEDURE-EXAMINING GROUP 3742

S/N 10/823,314

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Neo C. Peng et al.

Examiner: Samuel Heinrich

Serial No.: 10/823,314

Group Art Unit: 3742

Filed: April 13, 2004

Docket No.: 303.772US2

Confirmation No.: 4743

Title: WAFER DICING DEVICE AND METHOD

AMENDMENT & RESPONSE UNDER 37 C.F.R. 1.116

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Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In response to the Final Office Action mailed August 28, 2008, please amend the application as follows: